

HIGH-PERFORMANCE CMOS BUS INTERFACE REGISTER

IDT74FCT823AT/CT

FEATURES:

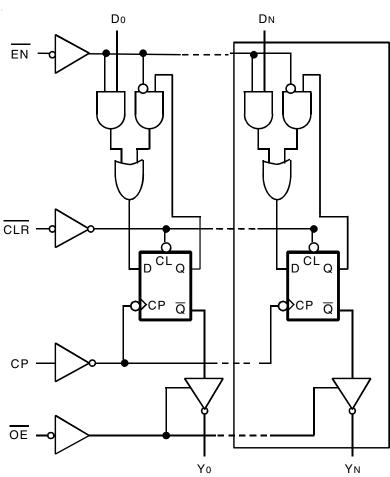
- A and C grades
- Low input and output leakage ≤1µA (max.)
- CMOS power levels
- True TTL input and output compatibility:
 - VOH = 3.3V (typ.)
 - -VOL = 0.3V(typ.)
- High Drive outputs (-15mA IOH, 48mA IOL)
- Meets or exceeds JEDEC standard 18 specifications
- Power off disable outputs permit "live insertion"
- · Available in the SOIC and QSOP packages

DESCRIPTION:

The FCT823T series is built using an advanced dual metal CMOS technology. The FCT823T series bus interface registers are designed to eliminate the extra packages required to buffer existing registers and provide extra data width for wider address/data paths or buses carrying parity. The FCT823T is a 9-bit wide buffered register with Clock Enable (\overline{EN}) and Clear (\overline{CLR}) – ideal for parity bus interfacing in high-performance microprogrammed systems.

The FCT823T high-performance interface family can drive large capacitive loads, while providing low-capacitance bus loading at both inputs and outputs. All inputs have clamp diodes and all outputs are designed for low-capacitance bus loading in high-impedance state.

FUNCTIONAL BLOCK DIAGRAM

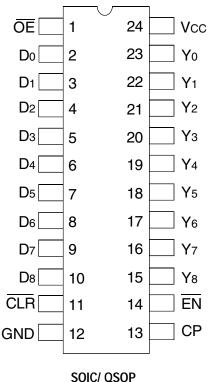


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February 19, 2009

INDUSTRIAL TEMPERATURE RANGE

PINCONFIGURATION



TOP VIEW

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Description	Max	Unit
VTERM ⁽²⁾	Terminal Voltage with Respect to GND	–0.5 to +7	٧
VTERM ⁽³⁾	Terminal Voltage with Respect to GND	-0.5 to Vcc+0.5	٧
Tstg	Storage Temperature	-65 to +150	°C
Ιουτ	DC Output Current	-60 to +120	mA

NOTES:

 Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability. No terminal voltage may exceed Vcc by +0.5V unless otherwise noted.

2. Inputs and Vcc terminals only.

3. Output and I/O terminals only.

CAPACITANCE (TA = +25°C, F = 1.0MHz)

Symbol	Parameter ⁽¹⁾	Conditions	Тур.	Max.	Unit
Cin	Input Capacitance	VIN = 0V	6	10	pF
Соит	Output Capacitance	Vout = 0V	8	12	pF

NOTE:

1. This parameter is measured at characterization but not tested.

PIN DESCRIPTION

Pin Names	I/O	Description
Dx	-	D Flip-Flop Data Inputs
CLR	Ι	When the clear input is LOW and \overline{OE} is LOW, the Ox outputs are LOW. When the clear input is HIGH, data can be entered into the register.
СР	Ι	Clock Pulse for the Register; enters data into the register on the LOW-to-HIGH transition.
Yх	0	Register 3-State Outputs
ĒN	I	Clock Enable. When the clock enable is LOW, data on the Dx output is transferred to the Qx output on the LOW-to-HIGH transition. When the clock enable is HIGH, the Qx outputs do not change state, regardless of the data or clock input transitions.
ŌĒ	I	Output Control. When the \overline{OE} is HIGH, the Yx outputs are in the high-impedance state. When the \overline{OE} is LOW, the TRUE register data is present at the Yx outputs.

FUNCTION TABLE⁽¹⁾

	Inputs					rnal/ outs	
ŌĒ	CLR	ĒN	Dx	СР	Qx	Үх	Function
Н	Н	L	L	↑	L	Z	High Z
Н	Н	L	Н	↑	Н	Z	
Н	L	Х	Х	Х	L	Z	Clear
L	L	Х	Х	Х	L	L	
Н	Н	Н	Х	Х	NC	Z	Hold
L	Н	Н	Х	Х	NC	NC	
Н	Н	L	L	↑	L	Z	Load
Н	Н	L	Н	↑	Н	Z	
L	Н	L	L	↑	L	L	
L	Н	L	Н	\uparrow	Н	Н	

NOTE:

1. H = HIGH Voltage Level

X = Don't Care

L = LOW Voltage Level

NC = No Change

 \uparrow = LOW-to-HIGH Transition Z = High Impedance

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified: Industrial: TA = -40° C to $+85^{\circ}$ C, VCC = $5.0V \pm 5\%$

Symbol	Parameter	Test Cond	itions ⁽¹⁾	Min.	Тур. ⁽²⁾	Max.	Unit
Vih	Input HIGH Level	Guaranteed Logic HIGH Level		2	—	_	V
VIL	Input LOW Level	Guaranteed Logic LOW Level		_	—	0.8	V
Ін	Input HIGH Current ⁽⁴⁾	Vcc = Max.	VI = 2.7V	_	-	±1	μA
١L	Input LOW Current ⁽⁴⁾	Vcc = Max.	VI = 0.5V	_	—	±1	μA
Іогн	High Impedance Output Current ⁽⁴⁾	Vcc = Max., VI = Vcc (Max.)	VI = 2.7V		—	±1	μA
Iozl			VI = 0.5V	_	—	±1	
lı	Input HIGH Current ⁽⁴⁾	Vcc = Max., VI = Vcc (Max.)	Vcc = Max., VI = Vcc (Max.)		—	±1	μA
Vik	Clamp Diode Voltage	Vcc = Min., IIN = -18mA		_	-0.7	-1.2	V
Vн	Input Hysteresis	_		—	200	_	mV
lcc	Quiescent Power Supply Current	Vcc = Max. Vin = GND or Vcc		-	0.01	1	mA

OUTPUT DRIVE CHARACTERISTICS

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Тур. ⁽²⁾	Max.	Unit
Vон	Output HIGH Voltage	Vcc = Min	Iон = –8mA	2.4	3.3	—	V
		VIN = VIH or VIL	Iон = –15mA	2	3	Ι	
Vol	Output LOW Voltage	Vcc = Min IoL = 48mA		—	0.3	0.5	V
		VIN = VIH or VIL					
los	Short Circuit Current	$Vcc = Max., Vo = GND^{(3)}$		-60	-120	-225	mA
IOFF	Input/Output Power Off Leakage ⁽⁵⁾	Vcc = 0V, VIN or Vo \leq 4.5V		_	_	±1	μA

NOTES:

1. For conditions shown as Min. or Max., use appropriate value specified under Electrical Characteristics for the applicable device type.

2. Typical values are at Vcc = 5.0V, +25°C ambient.

3. Not more than one output should be tested at one time. Duration of the test should not exceed one second.

4. The test limit for this parameter is $\pm 5\mu A$ at TA = $-55^\circ C.$

5. This parameter is guaranteed but not tested.

POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Conditi	ons ⁽¹⁾	Min.	Тур. ⁽²⁾	Max.	Unit
Δlcc	Quiescent Power Supply Current TTL Inputs HIGH	Vcc = Max. $VIN = 3.4V^{(3)}$		—	0.5	2	mA
ICCD	Dynamic Power Supply Current ⁽⁴⁾	Vcc = Max. Outputs Open OE = EN = GND One Input Toggling 50% Duty Cycle	Vin = Vcc Vin = GND	_	0.15	0.25	mA/ MHz
Ic	Total Power Supply Current ⁽⁶⁾	Vcc = Max. Outputs Open fcP = 10MHz 50% Duty Cycle	Vin = Vcc Vin = GND	_	1.5	3.5	mA
		OE = EN = GND One Bit Toggling at fi = 5MHz	VIN = 3.4V VIN = GND	_	2	5.5	
		Vcc = Max. Outputs Open fcp = 10MHz	Vin = Vcc Vin = GND	_	3.8	7.3 ⁽⁵⁾	
		50% Duty Cycle $\overline{OE} = \overline{EN} = GND$ Eight Bits Toggling at fi = 2.5MHz	VIN = 3.4V VIN = GND		6	16.3 ⁽⁵⁾	

NOTES:

1. For conditions shown as Min. or Max., use appropriate value specified under Electrical Characteristics for the applicable device type.

2. Typical values are at Vcc = 5.0V, +25°C ambient.

3. Per TTL driven input; (VIN = 3.4V). All other inputs at Vcc or GND.

4. This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.

5. Values for these conditions are examples of Δ Icc formula. These limits are guaranteed but not tested.

6. IC = IQUIESCENT + INPUTS + IDYNAMIC

IC = ICC + Δ ICC DHNT + ICCD (fCP/2+ fiNi)

Icc = Quiescent Current

 Δ Icc = Power Supply Current for a TTL High Input (VIN = 3.4V)

DH = Duty Cycle for TTL Inputs High

NT = Number of TTL Inputs at DH

ICCD = Dynamic Current caused by an Input Transition Pair (HLH or LHL)

fcp = Clock Frequency for Register Devices (Zero for Non-Register Devices)

fi = Output Frequency

Ni = Number of Outputs at fi

All currents are in milliamps and all frequencies are in megahertz.

SWITCHING CHARACTERISTICS OVER OPERATING RANGE

			FCT8	23AT	FCT	823CT	
Symbol	Parameter	Condition ⁽¹⁾	Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	Unit
t PLH	Propagation Delay	CL = 50pF	1.5	10	1.5	6	ns
t PHL	CP to Yx (\overline{OE} = LOW)	$RL = 500\Omega$					
		$CL = 300 pF^{(4)}$	1.5	20	1.5	12.5	ns
		$RL = 500\Omega$					
tsu	Set-up Time HIGH or LOW Dx to CP	CL = 50pF	4	—	3	_	ns
Ħ	Hold Time HIGH or LOW Dx to CP	$RL = 500\Omega$	2	—	1.5	-	ns
tsu	Set-up Time HIGH or LOW \overline{EN} to CP		4	—	3	-	ns
tΗ	Hold Time HIGH or LOW $\overline{\mathrm{EN}}$ to CP		2	_	0	_	ns
t PHL	Propagation Delay, CLR to Yx		1.5	14	1.5	8	ns
t REM	Recovery Time CLR to CP		6	_	6	_	ns
tw	Clock Pulse Width HIGH or LOW		7	—	6	_	ns
tw	CLR Pulse Width LOW		6	—	6	_	ns
t PZH	Output Enable Time OE to Yx	CL = 50pF	1.5	12	1.5	7	ns
tPZL		$RL = 500\Omega$					
		$CL = 300 pF^{(4)}$	1.5	23	1.5	12.5	ns
		$RL = 500\Omega$					
t PHZ	Output Disable Time \overline{OE} to Yx	CL = 5pF ⁽⁴⁾	1.5	7	1.5	6	ns
tPLZ		$RL = 500\Omega$					
		CL = 50pF	1.5	8	1.5	6.5	ns
		$RL = 500\Omega$					

NOTES:

1. See test circuit and waveforms.

2. Minimum limits are guaranteed but not tested on Propagation Delays.

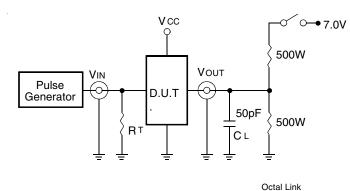
3. This parameter is guaranteed but not tested.

4. This condition is guaranteed but not tested.

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INDUSTRIAL TEMPERATURE RANGE

TEST CIRCUITS AND WAVEFORMS



Octai

Test Circuits for All Outputs

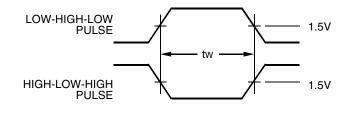
SWITCHPOSITION

Test	Switch
Open Drain Disable Low Enable Low	Closed
All Other Tests	Open

DEFINITIONS:

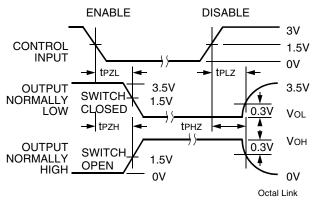
CL = Load capacitance: includes jig and probe capacitance.

RT = Termination resistance: should be equal to ZOUT of the Pulse Generator.



Pulse Width

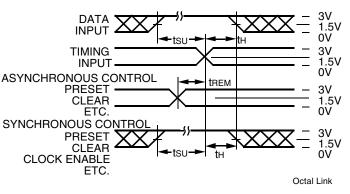
Octal Link



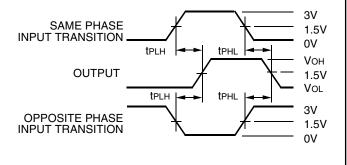
Enable and Disable Times

NOTES:

- 1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.
- 2. Pulse Generator for All Pulses: Rate \leq 1.0MHz; tF \leq 2.5ns; tR \leq 2.5ns.



Set-Up, Hold, and Release Times

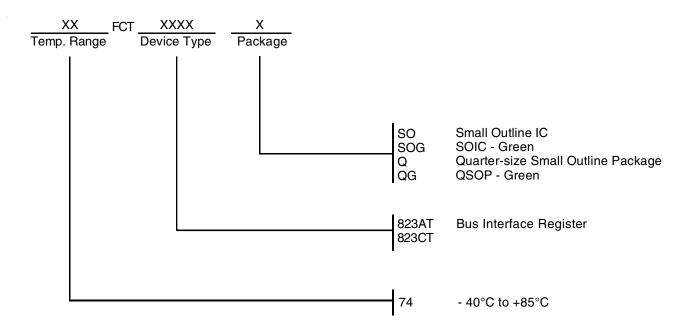


Propagation Delay

Octal Link

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